

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHING-CHUNG JOSH WONG	06/02/2015
RECEIVING PARTY DATA	
Name:	THE UNIVERSITY OF AKRON
Street Address:	302 E. BUCHTEL COMMON
City:	AKRON
State/Country:	OHIO
Postal Code:	44325
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14720117
CORRESPONDENCE DATA	
Fax Number:	(330)376-9646
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	330-376-1242
Email:	pto@rennerkenner.com
Correspondent Name:	RENNER KENNER GREIVE BOBAK TAYLOR & WEBE
Address Line 1:	106 SOUTH MAIN STREET, SUITE 400
Address Line 4:	AKRON, OHIO 44308-1412
ATTORNEY DOCKET NUMBER:	UOA.997.CIP
NAME OF SUBMITTER:	MARK L. WEBER
SIGNATURE:	/marklweber/
DATE SIGNED:	06/02/2015
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 1	
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Assignment

In Consideration of good and valuable consideration provided to the undersigned by the Assignee, The University of Akron, 302 E. Buchtel Common, Akron, Ohio 44325, the receipt of which is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said Assignee the entire right, title and interest in and to the improvement in:

ELECTROSPUN ALIGNED NANOFIBER ADHESIVES WITH MECHANICAL INTERLOCKS


said invention being fully described and/or claimed in the application for Letters Patent of the United States of America in and for the United States and all foreign countries, the same to be held and enjoyed by said Assignee, his successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patents therefore may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries of its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said Assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefore in said Assignee, his successors, assigns or other legal representatives and upon the request and at the expense of said Assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefore, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said Assignee, his successors, assigns or other legal representatives.

And The Commissioner of Patents is Hereby Authorized and Requested to issue any and all Letters Patents of the United States for said invention, to said Assignee.

Signed and sealed:



Shing-Chung Josh Wong

6/2/2015

Date